Application and Contract for Luncheon Seminar

10th DIA Medical Device Symposium in Japan



November 26, 2024 Hybrid Event at Nihonbashi Life Science HUB | Tokyo, Japan

| Company Contact Information Company Name (for signage and directory listing) | Billing Information Check here if billing address is the same as the contact's address | |
|---|--|---------------------|
| | Billing Company Name (for invoice) | |
| Contact Name (all correspondence will be sent to the contact information provided below) | Contact Name | |
| Address Line 1 | | |
| | Address Line 1 | |
| Address Line 2 | Address Line 2 | |
| City, State/Province, Postal Code, Country | City, State/Province, Postal Code, Country | |
| Telephone Number | Email Address (where invoice should be sent) | |
| Email Address (required for confirmation) | | |
| | Payment Options and Inforn Payment may be made by credit card or bank transfe presentation time will not be assigned without payment in f | er. Please note tha |
| Seminar Fees: ☐ (¥300,000 + 10% Consumption Tax) = ¥330,000 | ☐ Credit Card payments by Visa,or MasterCard ONLY: ☐ VISA ☐ MC | |
| Services/Products to be exhibited: | Cardholder's Name: | |
| Cancellation and Downsizing Policy Cancellations requests MUST be in writing and may be emailed to Japan@DIAglobal.org. Cancellations requests received on or before: August 26, 2024 will receive a 75% refund. Cancellations requests received on or before: September 26, 2024 will receive a 50% refund. Cancellations requests received after: October 26, 2024 will receive NO refund. | Exp. Date: Signature: Bank Transfers should be made to: MIZUHO BANK LTD., Kamiyacho branch, Toranomon 45 MT Bldg, 5-1-5 Toranomon Minato-ku, Tokyo 105-0001 Japan DIA Japan Ordinary Account Number: 1273382 SWIFT Code: MHCBJPJT Company name, as well as the Meeting ID 24311 must be included or the transfer document to ensure payment to your account. Payment does no denote approval of your application to exhibit. If application is denied a ful refund will be processed. All local and overseas charges incurred for the bank transfer must be borne by payer. | |
| | Contract Signature The undersigned hereby authorizes DIA to reserve the presentation time during designtated slot for use by the above company or organization during the 10th DIA Medical Device Symposium in Japan. DIA reserves the right in its solution and absolute discretion to reject any application that in its judgment does not enhance the purpose of 10th DIA Medical Device Symposium in Japan and it associated Exposition or is in direct competition with DIA. This contract shall be deemed accepted by DIA when received, together with the required payment However, no contract shall be deemed accepted if the contracting exhibits has outstanding financial obligations to DIA, of which DIA is aware, for the presentation, or any service(s) provided by DIA. | |
| | Authorized signature | Date |
| | | |

Luncheon Seminar Contact: DIA Japan Officei Phone: +81.3.6214.0574 Nihonbashihoncho, Chuo-ku email: Japan@DIAglobal.org

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